

# FLIRLEPTON 3°

## High Resolution Micro Thermal Camera

The FLIR Lepton 3, FLIR's highest resolution LWIR micro thermal camera solution, delivers full 160 x 120 thermal resolution — a 4x increase over earlier Lepton versions. The revolutionary Lepton was the first complete longwave infrared thermal camera small enough to be used in smartphones and other mobile devices. The new, higher resolution Lepton 3 gives users better image detail in a powerful, compact, lightweight package for even greater utility in commercial applications as both a thermal camera and a detection sensor. Smaller than a dime and ten times less expensive than a traditional IR camera, the 160 x 120 resolution Lepton brings high quality thermal vision everywhere.

#### **ENHANCED IR SENSOR**

Greater resolution & sensitivity than common thermopile arrays

- 160 x 120 active pixels
- Thermal sensitivity <50 mK
- Low operating power 140 mW typical, 650 mW during shutter event
- Low power standby mode

### **MICRO THERMAL IMAGER**

Uncooled thermal imaging for small electronics

- 56° lens
- Integrated digital thermal image processing
- Integrated shutter
- Fast time to image (<0.5 seconds)

#### **EASE OF INTEGRATION**

Simplifies development & manufacturing of thermal-enabled devices

- Small 11.8 x 12.7 x 7.2 mm package
- SPI video interfaces
- Uses standard cell phone-compatible power supplies
- Two-wire serial control interface
- 32-pin socket interface to connector



## **Specifications**

Overview	Lepton 3
Sensor technology	Uncooled VOx microbolometer
Spectral range	Longwave infrared, 8 µm to 14 µm
Array format	160 x 120, progressive scan
Pixel size	12 µm
Effective frame rate	8.8 Hz (commercial application exportable)
Thermal sensitivity	<50 mK (0.050° C)
Temperature compensation	Automatic. Output image independent of camera temperature.
Non-uniformity corrections	Automatic with shutter
Scene dynamic range	Low Gain Mode: up to 450°C; High Gain Mode: up to 150°C
Image optimization	Factory configured and fully automated
FOV - horizontal	56°
FOV - diagonal	71°
Output format	User-selectable 14-bit, 8-bit (AGC applied), or 24-bit RGB (AGC and colorization applied)
Solar protection	Integral
Electrical	
Input clock	25-MHz nominal, CMOS IO Voltage Levels
Video data interface	Video over SPI
Control port	CCI (I2C-like), CMOS IO Voltage Levels
Input supply voltage (nominal)	2.8 V, 1.2 V, 2.8 V to 3.1 V IO
Power dissipation (Typical, room temp)	140 mW (operating), 650 mW (during shutter event), 4 mW (standby)
Mechanical	
Package dimensions – socket version (w x l x h)	11.8 x 12.7 x 7.2 mm
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Weight	0.9 grams
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Weight	0.9 grams -10°C to +65°C
Weight  Environmental Optimum operating	

CORPORATE **HEADQUARTERS** 

FLIR Systems, Inc. 27700 SW Parkway Ave. Wilsonville, OR 97070 PH: +1 877.773.3547

SANTA BARBARA

FLIR Systems, Inc. 6769 Hollister Ave. Goleta, CA 93117 PH: +1 805.690.6602

FLIR Systems Co., Ltd Room 502, West Wing, Hanwei Building No. 7 Guanghua Ave. Chaoyang District, Beijing 100004, China Phone: +86 10-59797755

EUROPE FLIR Systems, Inc. Luxemburgstraat 2 2321 Meer

Belgium PH: +32 (0) 3665 5100

www.flir.com NASDAQ: FLIR

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